



1F12

AMENDMENT TRANSMITTAL LETTER

Docket No.
SON-2050

Application No.
09/808,957-Conf. #5303

Filing Date
March 16, 2001

Examiner
M. Lewis

Art Unit
2822

Applicant(s): Hisao Hayashi

Invention: THIN FILM SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF

TO THE COMMISSIONER FOR PATENTS

Transmitted herewith is a preliminary amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED					
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate	
Total Claims	25	- 28 =		x	
Independent Claims	3	- 6 =		x	
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					
Other fee (please specify):					
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:					0.00

- ☒ Large Entity ☐ Small Entity
- ☒ No additional fee is required for this preliminary amendment.
- ☐ Please charge Deposit Account No. _____ in the amount of \$ _____.
A duplicate copy of this sheet is enclosed.
- ☐ A check in the amount of \$ _____ to cover the filing fee is enclosed.
- ☐ Payment by credit card. Form PTO-2038 is attached.
- ☒ The Director is hereby authorized to charge and credit Deposit Account No. 18-0013
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- ☒ Credit any overpayment.
- ☒ Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.

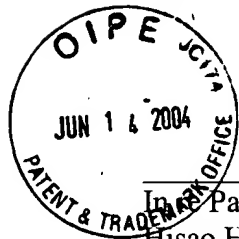
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Dated: June 14, 2004

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Patent Application of:
Hisao HAYASHI

Confirmation No.: 5303

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For: THIN FILM SEMICONDUCTOR DEVICE
AND MANUFACTURING METHOD
THEREOF

SUPPLEMENTAL AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In further response to the Office Action dated February 13, 2004, finally rejecting claims 22-28, 31-37 and 40-49, please amend the above-identified U.S. patent application as follows:

Amendments to the Specification are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.